

Electronic Patent Application Fee Transmittal

Application Number:	10519837			
Filing Date:	05-Jul-2005			
Title of Invention:	HIGH-RESISTANCE SILICON WAFER AND PROCESS FOR PRODUCING THE SAME			
First Named Inventor/Applicant Name:	Shinsuke Sadamitsu			
Filer:	Marvin Jay Spivak/Aida Melaku			
Attorney Docket Number:	264197US0PCT			
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U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
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Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appt Issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

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Total in USD (\$)				1740